

Aerospace Potting Solutions



STRENGTHENING THE CORE

Henkel offers a broad variety of potting, edge fill and encapsulating compounds to use with various substrates, operating temperatures and other environmental factors. All provide improved mechanical strength, as well as resistance to vibration, shock and thermal stress.

These syntactic paste or film products are comprised of epoxy foam materials filled with micro-balloons that provide structural performance with reduced density to address aerospace interior and manufacturing needs. Additionally, they protect against corrosion, dust and chemicals while providing electrical insulation. Due to their thermal properties they are ideally suited for a wide range of aerospace temperature requirements.

Benefits Include:

- Enable lightweighting
- High compressive strength at elevated temperature
- Reduced rework due to minimized microcracking and cell wall separation
- Improved mechanical strength
- Fire retardant options available
- Approved to major OEM specifications
- Non-halogenated options (REACh Compliant)
- Environmental, Health and Safety (EHS) REACh Compliance benefits
- Automatable upscaled robotic dispensing possible for paste materials
- Machinable/Drillable materials can be machined and drilled after full cure
- Global product availability and technical support



Low Density:

Lightweight with good compressive strength

Product	LOCTITE® HC 3056™	LOCTITE [®] 9396.6 MD
Description	LOCTITE [®] HC 3056 [™] is a two component low-density potting compound with very low moisture penetration due to its closed cell structure. This self-extinguishing, thixotropic, is ideally suited for use in honeycomb panels for edge close out, insert potting and smoothing. Additionally, it can easily and safely be cleaned with the use of hot, soapy water rather than solvents.	LOCTITE [®] 9396.6 MD is an easy mixing, two-part syntactic epoxy adhesive with good compressive strength at higher temperatures.
Flammability (FR or FST)	FR	
Form	Paste	Paste
System (1K or 2K)	2К	2К
Color	White	Lt. Blue
Density, g/cm³ (lbs/ft³)	0.48 (30)	0.55 (34)
Compression (Ultimate) at RT, ksi (MPa)	3.0 (20.7)	6.1 (41.7)
Storage, °F (°C)	≤77°F (25°C)	≤0°F (-18°C)
Shelf Life (months)	12	12
Pot Life at 77°F (25°C)	1 hr.	2 hr
Cure Temp., °F (°C)	77°F (25°C)	77°F (25°C)

Intermediate Density:

High compressive strength at temperatures up to 350°F, make these products perfect for potting and panel edge reinforcing.

Product	LOCTITE [®] EA 9814 [™]	LOCTITE [®] EA 9820 [™]	LOCTITE [®] EA 9825 [™]
Description	LOCTITE [®] EA 9814 ^{°°} AERO is an intermediate density, fire retardant, one- component epoxy syntactic for use on honeycomb composite parts requiring high compressive strength at temperatures up to 350°F (177°C).	LOCTITE [®] EA 9820 [™] is an intermediate density, one-component epoxy syntactic for use on honeycomb composite parts requiring high compressive strength at temperatures up to 350°F (177°C). It may also be used for fastener or attachment potting and panel edge reinforcing.	LOCTITE® EA 9825" is an intermediate density, one-component epoxy syntactic for use on honeycomb composite parts requiring high compressive strength at temperatures up to 350°F (177°C). It may also be used for fastener or attachment potting and panel edge reinforcing.
Flammability (FR or FST)	FR		
Form	Paste	Paste	Paste
System (1K or 2K)	1К	1К	1К
Color	Off-White	Amber	Amber
Density, g/cm ³ (lbs/ft ³)	0.75 (47)	0.87 (54)	0.72 (45)
Compression (Ultimate) at RT, ksi (MPa)	15.4 (105.9)1	22.7 (156.6)1	13.2 (91.0)1
Storage, °F (°C)	-20°F (-30°C)	≤0°F (-18°C)	≤0°F (-18°C)
Shelf Life (months)	12	12	12
Pot Life at 77°F (25°C)	>8 hrs.	>8 hrs.	>8 hrs.
Cure Temp., °F (°C)	260°F (127°C) 350°F (177°C)	250°F (121°C) 350°F (177°C)	250°F (121°C) 350°F (177°C)

Variable Density:

These syntactic film products expand using unique closed cell process, making ideal for core fill and stabilization.

Product	LOCTITE [®] EF 9899 [™]	LOCTITE [®] EF 9899 CF [™]
Description	LOCTITE [®] EF 9899 ^{°°} is an expanding syntactic film. It expands using a unique closed cell process, providing for a completely homogenous cell structure. Its applications include honeycomb core stabilization, edge close out, RTM core, and many others.	LOCTITE [®] EF 9899 CF [™] is a medium density low exotherm expanding syntactic film suitable for core filling applications. Its typical cured density range is 18 – 35 pcf (0.29 – 0.56 g/cc). The low exotherm chemistry makes this product ideal for deep core fill. Additionally, high compressive strength provides the potential for some structural applications.
Form	Film	Film
System (1K or 2K)	1К	1К
Color	Yellow	Green
Density, g/cm3 (lbs/ft3)	0.13-0.40 (8-25)	0.29-0.56 (18-35)
Compression (Ultimate) at RT, ksi (MPa)	0.58 (4.0)2	6.8 (47.2)3 7.8 (53.5)4
Storage, °F (°C)	≤0°F (-18°C)	≤0°F (-18°C)
Shelf Life (months)	12	12
Pot Life at 77°F (25°C)	15 days	15 days
Cure Temp., °F (°C)	250°F (121°C) 350°F (177°C)	250°F (121°C) 350°F (177°C)

Fire Retardant Potting Materials:

Flame retardant toughened epoxy paste materials with excellent mechanical strength for edge filling and structural potting interior applications.

Product	LOCTITE® HC 3056 [™]	LOCTITE [®] EA 9814
Description	LOCTITE [®] HC 3056 [™] is a two component low-density potting compound with very low moisture penetration due to its closed cell structure. This self-extinguishing, thixotropic, is ideally suited for use in honeycomb panels for edge close out, insert potting and smoothing. Additionally, it can easily and safely be cleaned with the use of hot, soapy water rather than solvents.	LOCTITE [®] EA 9814 AERO is an intermediate density, fire retardant, one-component epoxy syntactic for use on honeycomb composite parts requiring high compressive strength at temperatures up to 350°F (177°C). Additionally it offers environmentally sustainable benefits, as it is halogen, antimony and phenol free.
Flammability (FR or FST)	FR	FR
Form	Paste	Paste
System (1K or 2K)	2К	1К
Color	White	Off-White
Density, g/cm ³ (lbs/ft ³)	0.48 (30)	0.75
Compression (Ultimate) at RT, ksi (MPa)	3.0 (20.7)	15.4 (105.9)1
Storage, °F (°C)	≤77°F (25°C)	-20°F (-30°C)
Shelf Life (months)	12	12
Pot Life at 77°F (25°C)	1 hr	>8 hrs.
Cure Temp., °F (°C)	77°F (25°C)	260°F (127°C) 350°F (177°C)



USA Henkel Corporation 32100 Stephenson Highway Madison Heights, MI 48071 866.332.7024

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